

NPN Silicon RF Transistor*

- For low noise, low distortion broadband amplifiers in antenna and telecommunications systems up to 1.5 GHz at collector currents from 20 mA to 80 mA
- 4 2 3
- Power amplifier for DECT and PCN systems
- $f_T = 7.5 \text{ GHz}$, F = 1.3 dB at 900 MHz
- Pb-free (RoHS compliant) package¹⁾
- Qualified according AEC Q101
- * Short term description





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration					Package	
BFG196	BFG196	1 = E	2 = B	3 = E	4 = C	•	•	SOT223

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$	12	V
Collector-emitter voltage	V_{CES}	20	
Collector-base voltage	V_{CBO}	20	
Emitter-base voltage	V_{EBO}	2	
Collector current	I _C	150	mA
Base current	I _B	15	
Total power dissipation ²⁾	P_{tot}	800	mW
<i>T</i> _S ≤ 90°C			
Junction temperature	T_{i}	150	°C
Ambient temperature	T_{A}	-65 150	
Storage temperature	$T_{ m stg}$	-65 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ³⁾	R_{thJS}	≤ 75	K/W

¹Pb-containing package may be available upon special request

 $^{^2}T_{\mbox{\scriptsize S}}$ is measured on the collector lead at the soldering point to the pcb

 $^{^3}$ For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics				•	•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$, ,				
Collector-emitter cutoff current	I _{CES}	-	-	100	μΑ
$V_{CE} = 20 \text{ V}, \ V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{ V}, I_{\rm C} = 0$					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, pulse measured					



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

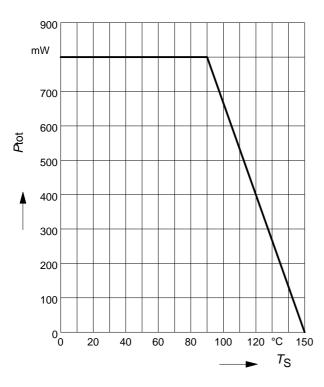
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	g)	1		T	
Transition frequency	f_{T}	5	7.5	-	GHz
$I_{\rm C} = 70 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ f = 500 \text{ MHz}$					
Collector-base capacitance	C _{cb}	-	0.85	1.3	pF
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0$,					
emitter grounded					
Collector emitter capacitance	C_{ce}	-	0.45	-	
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	4.2	-	
$V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0$,					
collector grounded					
Noise figure	F				dB
$I_{\rm C} = 20 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm Sopt},$					
f = 900 MHz		-	1.3	-	
$I_{\text{C}} = 20 \text{ mA}, V_{\text{CE}} = 8 \text{ V}, Z_{\text{S}} = Z_{\text{Sopt}}$,					
f = 1.8 GHz		-	2.3	-	
Power gain, maximum available ¹⁾	G _{ma}				
$I_{\rm C} = 50 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm Sopt} \ ,$					
$Z_{L} = Z_{Lopt}$, $f = 900 \text{ MHz}$		-	14.5	-	
$I_{\rm C} = 50 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm Sopt} \ ,$					
$Z_{L} = Z_{Lopt}$, $f = 1.8 \text{ GHz}$		-	9	-	
Transducer gain	S _{21e} ²				dB
$I_{\rm C} = 50 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \Omega$					
f = 900 MHz		-	12	-	
$I_{\rm C} = 50 \text{ mA}, \ V_{\rm CE} = 8 \text{ V}, \ Z_{\rm S} = Z_{\rm L} = 50 \Omega$					
f = 1.8 GHz		_	6.5	-	

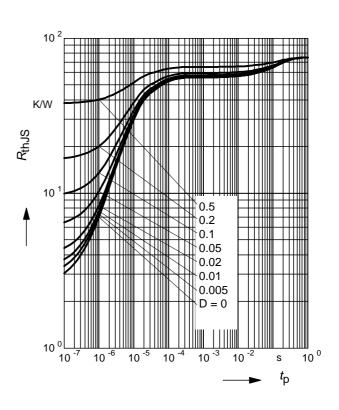
 $^{{}^{1}}G_{\text{ma}} = |S_{21} / S_{12}| (k-(k^2-1)^{1/2})$



Total power dissipation $P_{tot} = f(T_S)$

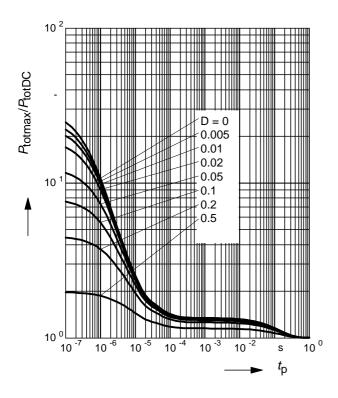
Permissible Pulse Load $R_{thJS} = f(t_p)$



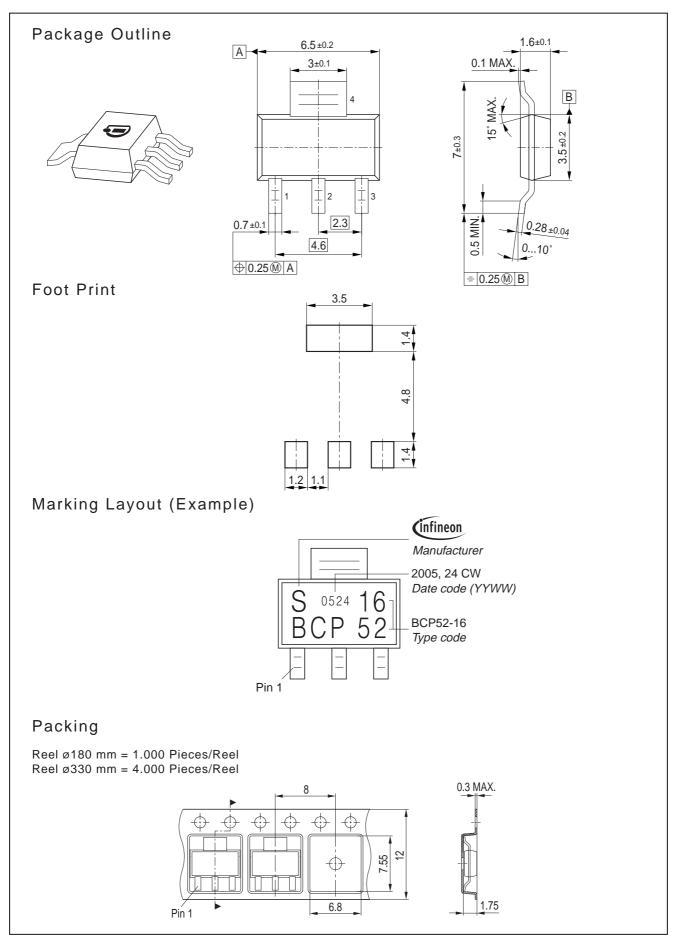


Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$$









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